Technical Document

LED Specification

EC/Opto Group

GW5BDF15L00 LED for Lighting Applications

Product Specification August 2010

"Zenigata" 6.7 W Module: High-output, 2800 K LED Module (400 lm), 69 CRI, suited for lighting applications



]	SPEC N ISSUE:	Io. DG-088020B August 03, 2010
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	51						
Mode	l No.			GW	5BDF15L00		
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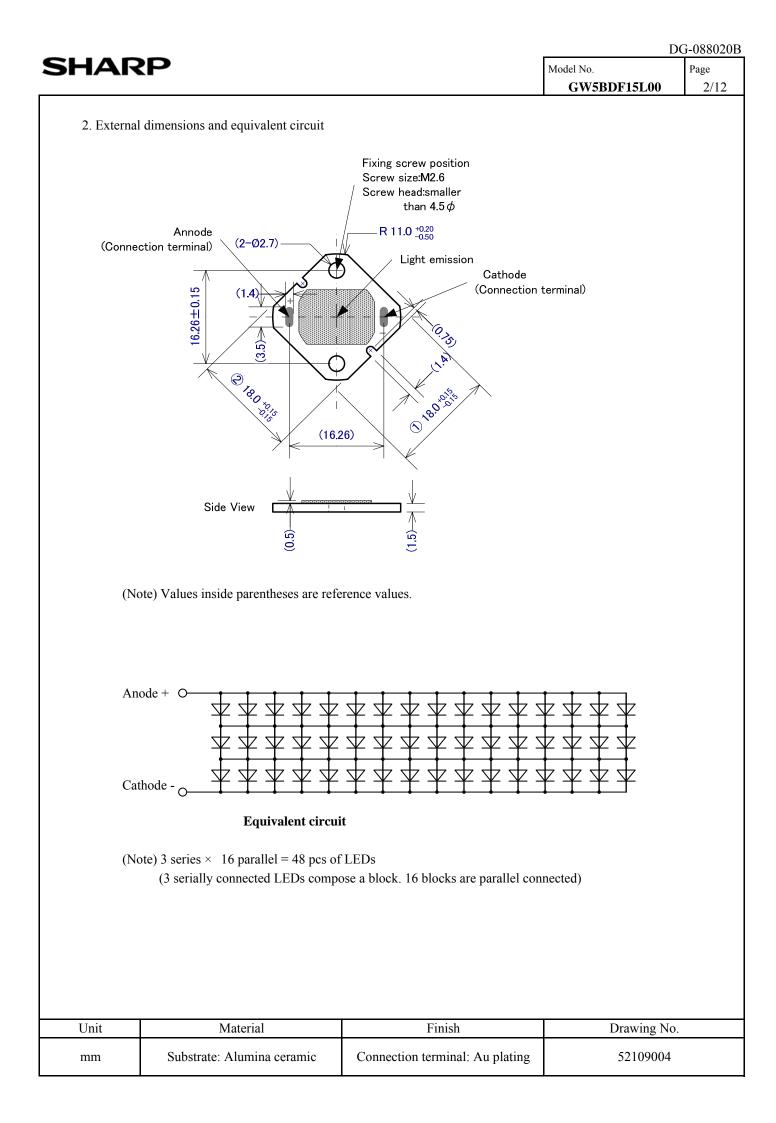
- Handle this document carefully for it contains material protected by international copyright law. Any reproduction, full or in part, of this material is prohibited without the express written permission of the company.
- When using the products covered herein, please observe the conditions written herein and the precautions outlined in the following paragraphs. In no event shall the company be liable for any damages resulting form failure to strictly adhere to these conditions and precautions.
 - (1) Please do verify the validity of this part after assembling it in customer's products, when customer wants to make catalogue and instruction manual based on the specification sheet of this part.
 - (2) The products covered herein are designed and manufactured for the following application areas. When using the products covered herein for the equipment listed in paragraph (3), even for the following application areas, be sure to observe the precautions given in Paragraph (3). Never use the products for the equipment listed in Paragraph (4).
 - •Office electronics
 - ·Instrumentation and measuring equipment
 - \cdot Machine tools
 - ·Audiovisual equipment
 - •Home appliances
 - ·Communication equipment other than for trunk lines
 - (3) These contemplating using the products covered herein for the following equipment which demands high reliability, should first contact a sales representative of the company and then accept responsibility for incorporating into the design fail-safe operation, redundancy, and other appropriate measures for ensuring reliability and safety of the equipment and the overall system.
 - ·Control and safety devices for airplanes, trains, automobiles, and other
 - transportation equipment
 - Mainframe computers
 - ·traffic control systems
 - ·Gas leak detectors and automatic cutoff devices
 - ·Rescue and security equipment
 - ·Other safety devices and safety equipment, etc.

(4) Do not use the products covered herein for the following equipment which

demands extremely high performance in terms of functionality, reliability, or accuracy.

- ·Aerospace equipment
- ·Communications equipment for trunk lines
- ·Control equipment for the nuclear power industry
- •Medical equipment related to life support, etc.
- (5) please direct all queries and comments regarding the interpretation of the above four Paragraphs to a sales representative of the company.
- Please direct all queries regarding the products covered herein to a sales representative of the company.

HARP	Model No. GW5BDF15L00	DG-0880 Page 1/1
<u>GW5BDF15L00 specifications</u>		
 Application These specifications apply to the light emitting diode module Model No. [Warm White (from InGaN Blue LED chip + Phosphor) LED module] Main application : Illumination 	GW5BDF15L00.	
2. External dimensions and equivalent circuit Refe	er to Page 2.	
 3. Ratings and characteristics Refe 3-1. Absolute maximum ratings 3-2. Electro-optical characteristics 3-3. Derating curve 3-4. Characteristics diagram (TYP.) 	er to Page 3 - 5.	
 4. Reliability Refe 4-1. Test items and test conditions 4-2. Failure criteria 	er to Page 6.	
 5. Quality label Refe 5-1. Applied standard 5-2. Sampling inspection 5-3. Inspection items and defect criteria 	er to Page 7.	
 6. Supplements Refer 6-1. Chromaticity rank table 6-2. Packing 6-3. Label 6-4. Indication printed on product 	r to Page 8 - 9.	
7. Precautions Refer	r to Page 10 - 12.	



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3. Ratings and characteristics

3-1. Absolute maximum ratings

Item	Symbol	Rating	Unit
Power Dissipation *1	Р	8.0	W
Forward Current *1	I _F	700	mA
Reverse Voltage *2	V _R	-15	V
Operating Temperature *3	T _{opr}	- $30 \sim +90$	°C
Storage Temperature	T _{stg}	- 40 ~ + 100	°C

*1 Power dissipation and forward current are the value when the module temperature is set lower than the rating by using an adequate heat sink.

*2 Voltage resistible at initial connection error

(Not dealing with the possibility of always-on reverse voltage.)

*3 Case temperature Tc (Refer to measuring point for case temperature in the next page.)

Refer to "Derating curve" in the next page as for operating current.

*4 $T_c = 25 \,^{\circ}C$

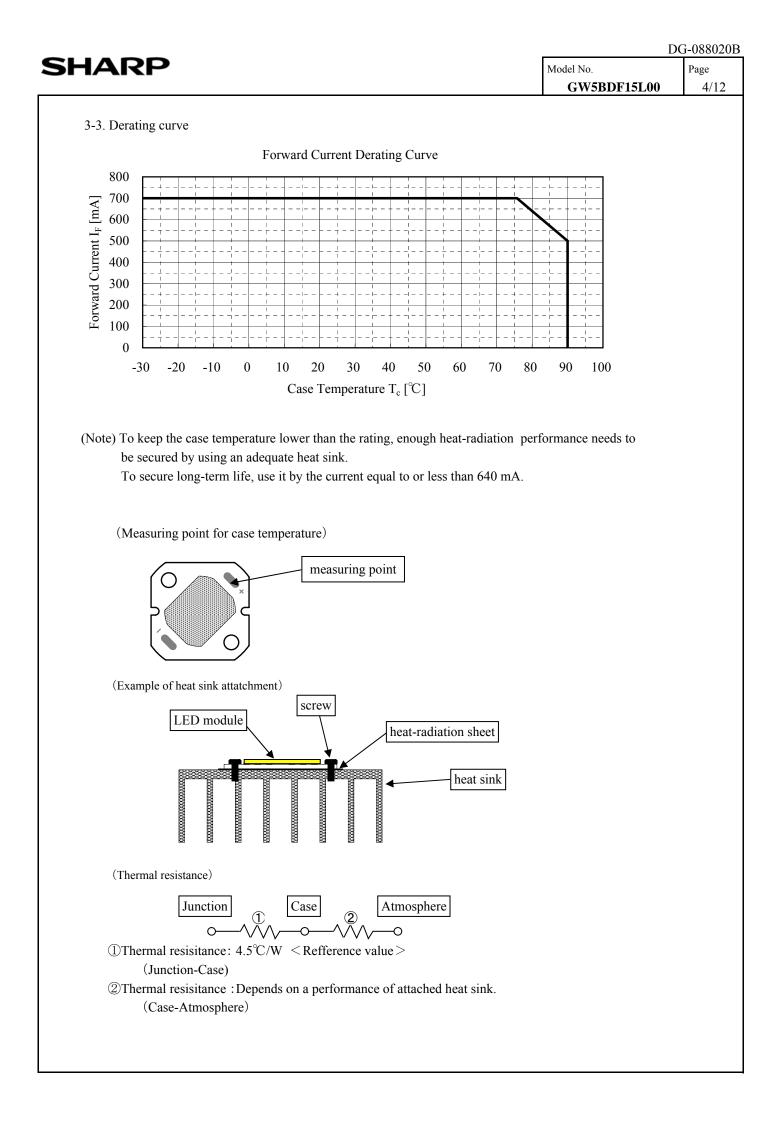
3-2. Electro-optical characteristics

						$(T_c = 25 \ ^{\circ}C)$
Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Forward Voltage *5	V _F	$I_{\rm F} = 640 \ {\rm mA}$	8.5	(10.2)	11.5	V
Luminous Flux *6	Φ	$I_{\rm F} = 640 \ {\rm mA}$	300	(400)	-	lm
Chromaticity Coordinates *7	х	$I_{\rm F} = 640 \ {\rm mA}$	-	0.452	-	-
	У		-	0.409	-	-
Color Temperature	-	$I_{\rm F} = 640 \ {\rm mA}$	(2550)	2800	(3050)	K

(Note) Values inside parentheses are shown for reference purpose only.

*5 (After 20 ms drive, Measurement tolerance: ± 3 %)

- *6 Monitored by Sharp's 8 inch integrating sphere and Otsuka electronics MCPD-LE3400 (After 20 ms drive, Measurement tolerance: ± 20 %)
- *7 Monitored by Sharp's 8 inch integrating sphere and Otsuka electronics MCPD-LE3400 (After 20 ms drive, Measurement tolerance: ± 0.02)

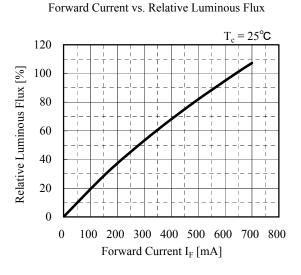


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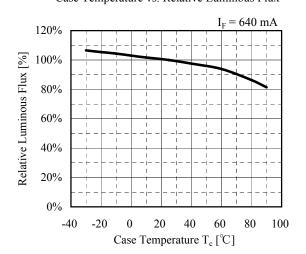
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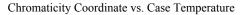
3-4. Characteristics diagram (TYP.)

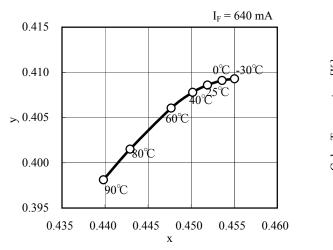
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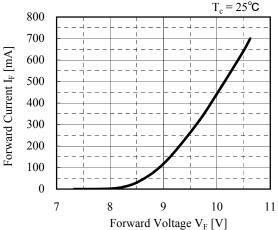
Case Temperature vs. Relative Luminous Flux

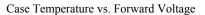


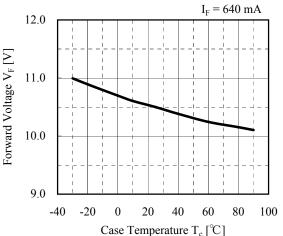


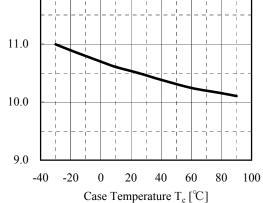


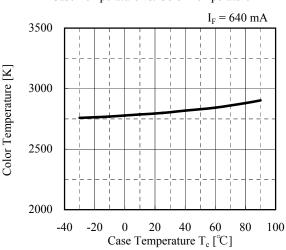
Forward Voltage vs. Forward Current











Case Temperature vs. Color Temperature

(Note) Characteristics data shown here are for reference purpose only. (Not guaranteed data)

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4. Reliability

The reliability of products shall be satisfied with items listed below.

4-1. T	est items and test conditio	ns	0	Confidence l	evel: 90 %
No.	Test item	Test conditions	Samples	Defective	LTPD
			n	С	(%)
1	Temperature Cycle	- 40 °C(30 min) \sim + 100 °C(30 min), 30 cycles			
			11	0	20
2	Temperature Humidity	$T_{stg} = +60 ^{\circ}\text{C}, \text{RH} = 90 ^{\circ}\text{, Time} = 1000 \text{ h}$			
	Storage		11	0	20
3	High Temperature	$T_{stg} = +100^{\circ}C$, Time = 1000 h			
	Storage		11	0	20
4	Low Temperature	$T_{stg} = -40 \text{ °C}, \text{ Time} = 1000 \text{ h}$			
	Storage		11	0	20
5	Steady State Operating	$T_c = 60 \text{ °C}, I_F = 700 \text{ mA}, \text{ Time} = 1000 \text{ h}$			
	Life		11	0	20
6	Shock	Acceleration: 15000 m/s ² , Pulse width: 0.5 ms			
		Direction: 3 directions (X, Y and Z)			
		3 trials in each direction	5	0	50
7	Vibration	Frequency: 100 to 2000 Hz for 4 minutes per trial			
		Acceleration: 200 m/s ²			
		Direction: 3 directions (X, Y and Z)			
		4 trials in each direction	5	0	50

4-2. Failure criter

1 2. 3	unure enter					
No.	No. Parameter Sy		Failure criteria			
1	1 Forward Voltage		$V_F > U.S.L imes 1.2$			
2	Luminous Flux	Φ	$\Phi \le$ Initial value × 0.5, $\Phi \ge$ Initial value × 2.0			

(Note) U.S.L. stands for Upper Specification Limit.

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5. Quality level

5-1. Applied standard

ISO2859-1

5-2. Sampling inspection

A single normal sampling plan, level S-4.

5-3. Inspection items and defect criteria

No.	Item	Defect criteria	Classification	AQL
1	No radiation	No light emitting	Major	
			defect	0.1%
2	Electro-optical	Not conforming to the specification		
	characteristics	(Forward voltage, Luminous flux and Chromaticity)	_	
3	External	Not conforming to the specified dimensions		
	dimensions	(External dimensions of (1) and (2) shown in Page 3)		
4	Appearance	Nonconformity observed in product appearance is determined	Minor	
		as defective only when electro-optical characteristics is affected by.	defect	0.4%
		<if above="" any="" arises="" criterion="" mentioned="" of="" question="" regardless=""></if>		
		■Foreign material, scratch, or bubble at emitting area: 0.8 mm φ		
		■Fiber generation at emitting area: 0.2 mm in width and 2.5 mm in length		
		■Foreign material at connection terminal: 0.8 mmφ		
		■Substrate burr on edge: Over dimension tolerance		
		■Resin chipping: 0.8 mmφ		

(Note) Products with removable foreign material attached on is not determined to be defective.

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6. Supplements

6-1. Chromaticity rank table

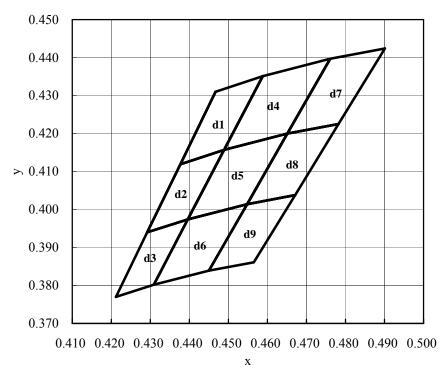
V	Warm White (2800 K)	2				$(I_F = 64)$	$0 \text{ mA, } T_c = 25 \text{ °C})$	
			Chromaticit	Chromaticity coordinates		Color temperature	$\Delta \mathbf{uv}$	
Rank		Point 1	Point 2	Point 3	Point 4	(K)		
d1	Х	0.447	0.438	0.449	0.459	$-2900 \sim 3050$	$0.003 \sim 0.009$	
aı	у	0.431	0.412	0.416	0.435	2900 ~ 3030	0.003 * 0.009	
د ۲	Х	0.438	0.429	0.440	0.449	$-2900 \sim 3050$	0.002 - 0.002	
d2	у	0.412	0.394	0.397	0.416	2900 ~ 3030	$-0.003 \sim 0.003$	
d3	Х	0.429	0.421	0.431	0.440	$-2900 \sim 3050$	$-0.009 \sim -0.003$	
u3	у	0.394	0.377	0.380	0.397	2900 ~ 3030	- 0.009 ~~ - 0.00	
d4	Х	0.459	0.449	0.465	0.476	$-2700 \sim 2900$	$0.003 \sim 0.009$	
u 4	у	0.435	0.416	0.420	0.440	2700 ~ 2900	0.003 ~ 0.009	
d5	Х	0.449	0.440	0.455	0.465	$-2700 \sim 2900$	$-0.003 \sim 0.003$	
u3	у	0.416	0.397	0.401	0.420	2700 ~ 2900	- 0.003 * 0.003	
d6	Х	0.440	0.431	0.445	0.455	$-2700 \sim 2900$	$-0.009 \sim -0.00$	
uo	у	0.397	0.380	0.384	0.401	2700 * 2900	- 0.009 - 0.003	
d7	х	0.476	0.465	0.478	0.490	$-2550 \sim 2700$	$0.003 \sim 0.009$	
u/	у	0.440	0.420	0.423	0.442	2330 - 2700	0.003 - 0.009	
d8	Х	0.465	0.455	0.467	0.478	$-2550 \sim 2700$	$-0.003 \sim 0.003$	
uð	у	0.420	0.401	0.404	0.423	2330 ~ 2700	- 0.003 / 0.003	
d9	Х	0.455	0.445	0.457	0.467	$-2550 \sim 2700$	$-0.009 \sim -0.003$	
u9	у	0.401	0.384	0.386	0.404	2330 ~ 2700	- 0.009 0.003	

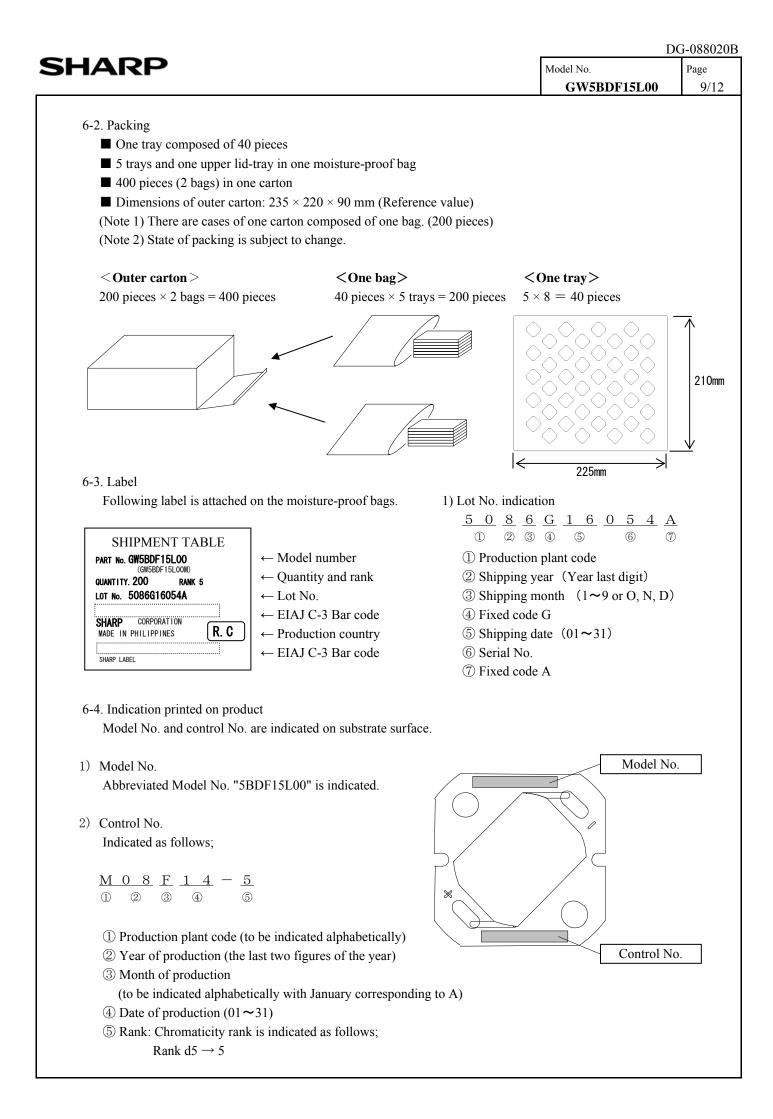
(Note 1) Quantity of each rank is decided by Sharp.

(Tolerance: $x,y \pm 0.02$)

(Note 2) Values of color temperature and $\triangle uv$ are shown for reference purpose only.

Chromaticity diagram





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7. Precautions		
① Storage conditions		
Please follow the conditions below.		
•Before opened: Temperature 5 \sim 30 °C, Relative humidity less than 60 %		
•After opened: Temperature 5 \sim 30 °C, Relative humidity less than 60 % (Plea	ase apply soldering within 1	week.
•Avoid exposing to air with corrosive gas.		
If exposed, electrode surface would be damaged, which may affect soldering.		
② Usage conditions		
The products are not designed for the use under any of the following condition	IS.	
Please confirm their performance and reliability well enough if you use under	any of the following conditi	ons;
• In a place with a lot of moisture, dew condensation, briny air, and corrosive g (Cl, H ₂ S, NH ₃ , SO ₂ , NO _X , etc.)	gas.	
•Under the direct sunlight, outdoor exposure, and in a dusty place.		
• In water, oil, medical fluid, and organic solvent.		
③ Heat radiation		
If the forward current (I_F) is applied to single-state module at 640 mA, there is	a risk of damaging module	
or emitting smoke.		
Equip with specified heat radiator, and avoid heat stuffed inside the module.		
Applying thermal conductive sheet or grease between module and heat radiato	r enables heat to radiate effe	ectively
④ Installation		
Material of board is alumina ceramic. If installed inappropriately, trouble of no	radiation may occur due to	
board crack. Please take particular notice of install method.	,	
Further information on installation, refer to the following cautions.		
• Apply ether screws or adhesives, or both of them when installed to heat rad	iator.	
In case of applying adhesive only, check the effectiveness before fixing.		
In case of screw, apply thread locker in order to prevent loosening.		
If LED comes off from the heat radiator, unusual temperature rise entails ha	azardous phenomena includ	ing
device deterioration, coming off of solder at leads, and emitting smoke.	1	U
• Refer to recommended dimensions when installing with screws.	(16.26 ± 0.05)	
• Screw torque: Within 0.2 Nm		
If it is inefficient to tighten screws, apply locker to prevent loosening.		- M2.6
• It is recommended to apply screws which use low corrosive materials	(\downarrow)	
such as Stainless steel.		
Avoid applying flat-head screws, which cause board crack		
due to applying stress to screw holes.		
Avoid convexly uneven boards.	×	
Those convex boards are subject to crack when tightening screws.		
• It is recommended to apply thermal conductive sheet or grease with adhesiv		
and heat radiating-adhesives, because of thermal and mechanical combinati	on	
between module and heat radiator.		
However, depending on their thickness, board crack may be entailed by wa	rned board which is	

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5	Module surface strength Module surface is subject to mechanical stress. Applying stress to surface of mod and internal failure.		
6	Connecting method		
	• In case of solder connecting method, follow the conditions mentioned below to p from alloy formation by terminal gold melted into solder.	prevent	
	Soldering iron with thermo controller (tip temperature 380 $^{\circ}$ C), within 10 second • Secure the solderwettability on whole solder pad and leads.	ls per one place.	
	• In soldering, put the ceramic board on materials whose conductivity is poor enounot to radiate heat of soldering.	ıgh	
	•Avoid touching yellow phosphor with soldering iron.		
	 This product is not designed for reflow and flow soldering. Avoid such lead arrangement as applying stress to solder-applied area. 		
\bigcirc	Static electricity		
	This product is subject to static electricity, so take measures to cope with it.		
	Install circuit protection device to drive circuit, if necessary.		
8	Drive method		
	• Any reverse voltage cannot be applied to LEDs when they are in operation or no Design a circuit so that any flow of reverse or forward voltage can not be applied when they are out of operation.		
	 There is a possibility of generating reverse voltage if ambient light is irradiated t This derives from reverse current caused by electromotive force generated by an 	• •	ion.
	Built in electromotive force-protection diodes or protect by insulating power sup •Module is composed of LEDs connected in both series and parallel.	-	tor.
	Constant voltage power supply runs off more than specified current amount due	to lowered V_F	
	caused by temperature rise. Constant current power supply is recommended to drive.		
9	Cleaning		
	Avoid cleaning, since silicone resin is eroded by cleaning.		
10	Color-tone variation		
	Chromaticity of this product is monitored by integrating sphere right after the op		
	Chromaticity varies depending on measuring method, light spread condition, or a Please verify your actual conditions before use.	implent temperature.	
11)	Safety		
	•Looking directly at LEDs for a long time may result in hurt your eyes.		
	• In case that excess current (over ratings) are supplied to the device, hazardous pl heat generation, emitting smoke, or catching fire can be caused.	nenomena including abnor	rmal
	Take appropriate measures to excess current and voltage.		
	•In case of solder connecting method, there is a possibility of fatigue failure by h	leat.	
	Please fix the leads in such case to protect from short circuit or leakage of electro	icity caused by contact.	
	• Plages confirm the selectly standards or regulations of application devices		

•Please fix the leads in such case to protect from short circuit or leakage of •Please confirm the safety standards or regulations of application devices.

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② Other cautions Guarantee covers the compliance to the quality standards mentioned in	the Specifications	
however it does not cover the compatibility with application of the end-		
and usage environment.	use, meruding assembly	
In case any quality problems occurred in the application of end-use, det	tails will be separately discussed	
and determined between the parties hereto.		

Opto Specification

Opto/EC Group

SHARP.

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